

IN THE CLAIMS:

Please cancel claims 1-5 without prejudice or disclaimer and amend claims 6-11 and 15-23 as follows:

1-5. (Cancelled)

6. (Currently Amended) The method of claim 5, A method for fabricating an image display device comprising an active matrix substrate having a pixel region formed with a large number of pixels arranged as a matrix and a drive circuit region formed with an active circuit for supplying a drive signal to said pixels from outside said pixel region, the method comprising the steps of:

forming a polycrystalline silicon film over said pixel region and said drive circuit region of said active matrix substrate;

selectively irradiating a portion of the polycrystalline silicon film located in said drive circuit region with a laser beam having a pulse width and/or a pulse interval modulated by scanning the laser beam or the substrate to form discrete reformed regions each composed of a quasi-strip-like-crystal silicon film resulting from reformation, said quasi-strip-like-crystal silicon film having a crystal boundary continuous in the direction of scanning; and

forming the active circuit such that a carrier moving direction coincides with a direction of said crystal boundary in each of said discrete reformed regions,

wherein the irradiation with said laser beam having the pulse width and/or pulse interval modulated is performed intermittently at specified intervals to form, into a generally rectangular configuration, each of individual reformed regions composing each of said discrete reformed regions, and

wherein the irradiation with said laser beam having the pulse width and/or pulse interval modulated is performed intermittently along one of the peripheral sides of the active matrix substrate to arrange the individual reformed regions composing each of said discrete reformed regions at specified intervals in a direction in which said drive circuit region extends.

7. (Currently Amended) The method of claim [[5]] 6, wherein the scanning with said laser beam having the pulse width and/or pulse interval modulated is performed reciprocally along one of the peripheral sides of the active matrix substrate to arrange the individual reformed regions composing each of said discrete reformed regions at specified intervals in a direction in which said drive circuit region extends.
8. (Currently Amended) The method of claim [[5]] 6, wherein the scanning with said laser beam having the pulse width and/or pulse interval modulated is performed along each of opposing two of the peripheral sides of the active matrix substrate to arrange the individual reformed regions composing each of said discrete reformed regions formed along each of the two sides at specified intervals in a direction in which said drive circuit region disposed along each of the two sides extends.
9. (Currently Amended) The method of claim [[5]] 6, wherein the scanning with said laser beam having the pulse width and/or pulse interval modulated is performed along one of the sides of the active matrix substrate and along a side adjacent to said one side to arrange the individual reformed regions composing each of said discrete reformed regions at specified intervals in a direction in which said drive circuit region disposed along said one side extends and in a direction in which said drive circuit region disposed along the adjacent side extends.
10. (Currently Amended) The method of claim [[5]] 6, wherein the scanning with said laser beam having the pulse width and/or pulse interval modulated is performed along each of opposing two of the sides of the active matrix substrate and along a side adjacent to each of said two sides to arrange the individual reformed regions composing each of said discrete reformed regions at specified intervals in a direction in which said drive circuit region disposed along each of said two sides extends and in a direction in which said drive circuit disposed along the adjacent side extends.
11. (Currently Amended) The method of claim [[5]] 6, wherein said plurality of discrete reformed regions are divided into blocks and said blocks are arranged in two or more rows parallel with each other in a direction in which said drive circuit region extends.

12. (Original) The method of claim 11, wherein the individual reformed regions composing each of the discrete reformed regions that have been divided into blocks are arranged in two or more rows parallel with each other in a direction in which said drive circuit region extends.
13. (Original) The method of claim 11, wherein said blocks of said discrete reformed regions are arranged in two or more rows parallel to each other in mutually staggered relation in a direction in which said drive circuit region extends.
14. (Original) The method of claim 13, wherein the individual reformed regions composing each of the discrete reformed regions that have been divided into blocks are arranged in two or more rows parallel with each other in mutually staggered relation in a direction in which said drive region extends.
15. (Currently Amended) The method of claim ~~[[1]]~~ 6, further comprising the step of:
forming, by a photolithographic technique, a positioning mark on the amorphous silicon film or the polycrystalline silicon film on said active matrix substrate.
16. (Currently Amended) The method of claim ~~[[1]]~~ 6, wherein the positioning mark on said active matrix substrate is formed preliminarily on said active matrix substrate or on an underlayer for the amorphous silicon film or the polycrystalline silicon film on the active matrix substrate.
17. (Currently Amended) The method of claim ~~[[1]]~~ 6, further comprising the step of:
forming the positioning mark on the amorphous silicon film or the polycrystalline silicon film on said active matrix substrate through irradiation with said laser having the pulse width and/or the pulse interval modulated.
18. (Currently Amended) The method of claim ~~[[1]]~~ 6, further comprising the step of:
forming a thin-film transistor in said active circuit.

19. (Currently Amended) The method of claim [[1]] 6, further comprising at least the steps of:
- bonding, to said active matrix substrate, a color filter substrate disposed in opposing relation thereto at a specified distance therefrom; and
 - sealing a liquid crystal in a space between said active matrix substrate and said color filter substrate.
20. (Currently Amended) The method of claim [[1]] 6, further comprising at least the steps of:
- forming an organic EL layer for each of the pixels composing said pixel region of said active matrix substrate; and
 - bonding a protective substrate to said active matrix substrate such that a surface formed with said organic EL layer of said active matrix substrate is covered therewith.
21. (Currently Amended) The method of claim [[1]] 6, wherein said laser beam is a solid-state laser having a wavelength of 200 nm to 1200 nm.
22. (Currently Amended) The method of claim [[1]] 6, wherein an irradiation width of said laser beam is 20 μm to 1000 μm .
23. (Currently Amended) The method of claim [[1]] 6, wherein a scanning speed of said laser beam or a scanning speed of said substrate is 50 mm/s to 3000 mm/s.